



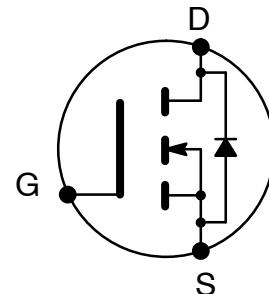
**NTE2928**  
**MOSFET**  
**N-Channel, Enhancement Mode**  
**High Speed Switch**  
**TO-220 Type Package**

**Features:**

- $R_{DS(on)} = 550\text{m}\Omega$  Max @  $V_{GS} = 10\text{V}$ ,  $I_D = 6\text{A}$
- Low Gate Charge:  $22\text{nC}$  Typ
- Low  $C_{RSS}$ :  $11\text{pF}$  Typ
- 100% Avalanche Tested

**Applications:**

- LCD/LED/PDP TV
- Lighting
- Uninterruptible Power Supply



**Absolute Maximum Ratings:** ( $T_C = +25^\circ\text{C}$  unless otherwise specified)

Drain-Source Voltage, $V_{DSS}$ .....	500V
Gate-Source Voltage, $V_{GSS}$ .....	$\pm 30\text{V}$
Drain Current, $I_D$ Continuous .....	11.5A
$T_C = +25^\circ\text{C}$ .....	11.5A
$T_C = +100^\circ\text{C}$ .....	6.9A
Pulsed (Note 1) .....	46A
Single Pulsed Avalanche Energy (Note 2), $E_{AS}$ .....	456mJ
Avalanche Current (Note 1), $I_{AR}$ .....	11.5A
Repetitive Avalanche Energy (Note 1), $E_{AR}$ .....	16.7mJ
Peak Diode Recovery $dv/dt$ (Note 3), $dv/dt$ .....	4.5V/ns
Power Dissipation ( $T_C = +25^\circ\text{C}$ ), $P_D$ .....	165W
Derate Above $+25^\circ\text{C}$ .....	1.33W/ $^\circ\text{C}$
Operating Temperature Range, $T_J$ .....	-55° to +150°C
Storage Temperature Range, $T_{stg}$ .....	-55° to +150°C
Maximum Lead temperature (During Soldering, 1/8" from case, 5 sec ), $T_L$ .....	+300°C
Maximum Thermal Resistance, Junction-to-Case, $R_{thJC}$ .....	0.75°C/W
Maximum Thermal Resistance, Junction-to-Ambient, $R_{thJA}$ .....	62.5°C/W

Note 1. Repetitive rating; pulse width limited by maximum junction temperature.

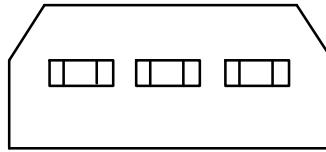
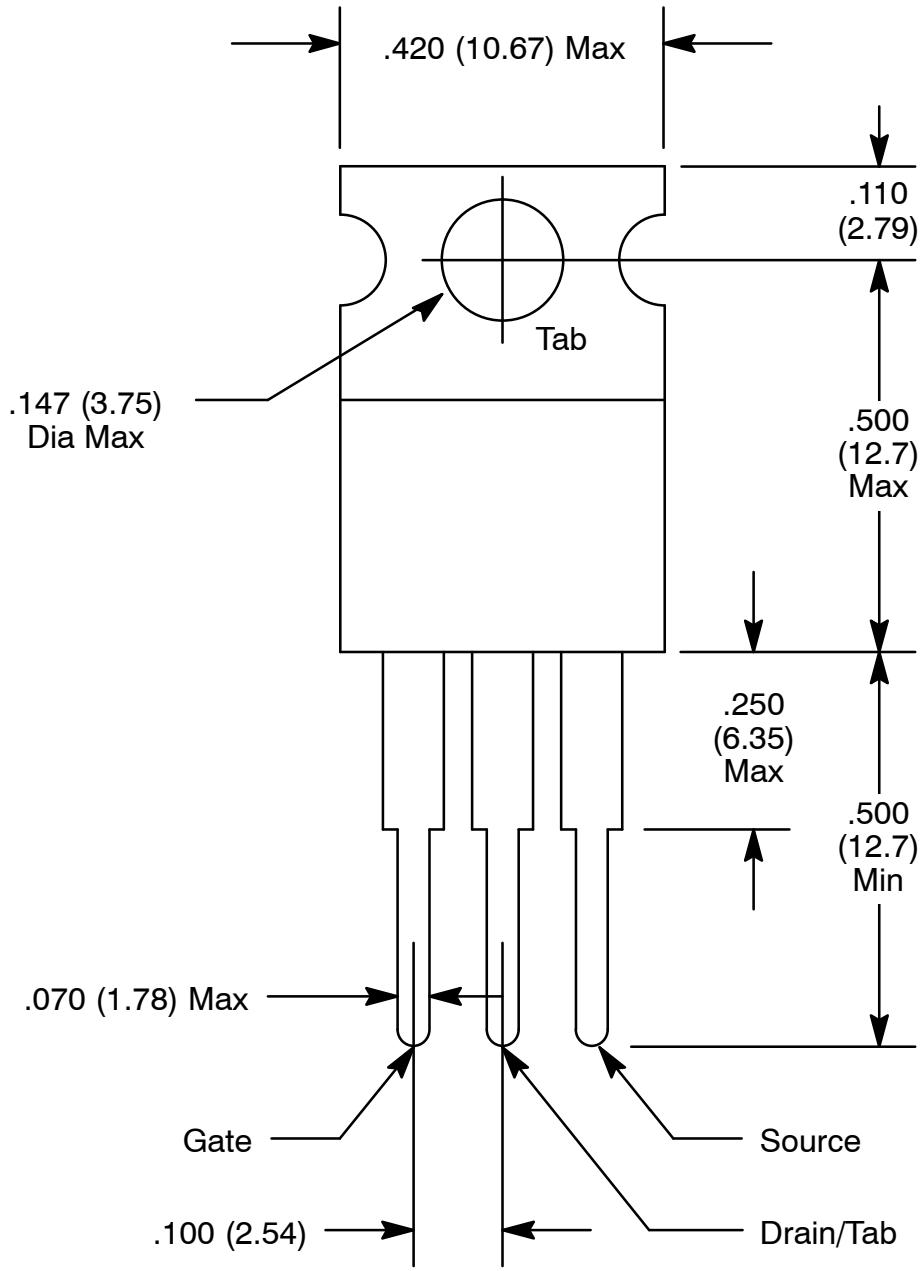
Note 2.  $L = 6.9\text{mH}$ ,  $I_{AS} = 11.5\text{A}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\Omega$ , starting  $T_J = +25^\circ\text{C}$ .

Note 3.  $I_{SD} \leq 11.5\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq V_{(BR)DSS}$ , starting  $T_J = +25^\circ\text{C}$ .

**Electrical Characteristics:** ( $T_C = +25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>OFF Characteristics</b>						
Drain–Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}, T_J = +25^\circ\text{C}$	500	—	—	V
Breakdown Voltage Temperature Coefficient	$\Delta V_{(\text{BR})\text{DSS}}/\Delta T_J$	$I_D = 250\mu\text{A}$ , Referenced to $+25^\circ\text{C}$	—	0.5	—	$\text{V}/^\circ\text{C}$
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{DS} = 500\text{V}, V_{GS} = 0$	—	—	1.0	$\mu\text{A}$
		$V_{DS} = 400\text{V}, T_C = +125^\circ\text{C}$	—	—	10	$\mu\text{A}$
Gate–Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 30\text{V}, V_{DS} = 0\text{V}$	—	—	$\pm 100$	nA
<b>ON Characteristics</b>						
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	3.0	—	5.0	V
Static Drain–Source ON Resistance	$R_{DS(\text{on})}$	$V_{GS} = 10\text{V}, I_D = 6\text{A}$	—	0.55	0.65	$\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = 40\text{V}, I_D = 6\text{A}$	—	11.5	—	S
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{V}, V_{DS} = 25\text{V}, f = 1\text{MHz}$	—	985	1315	pF
Output Capacitance	$C_{oss}$		—	140	190	pF
Reverse Transfer Capacitance	$C_{rss}$		—	11	17	pF
Total Gate Charge	$Q_g$	$V_{DD} = 400\text{V}, I_D = 11.5\text{A}, V_{GS} = 10\text{V}$ , Note 4	—	22	30	nC
Gate–Source Charge	$Q_{gs}$		—	6	—	nC
Gate–Drain Charge	$Q_{gd}$		—	9	—	nC
<b>Switching Characteristics</b>						
Turn–On Delay Time	$t_{d(\text{on})}$	$V_{DD} = 250\text{V}, I_D = 11.5\text{A}, V_{GS} = 10\text{V}, R_G = 25\Omega$ , Note 4	—	24	60	ns
Rise Time	$t_r$		—	50	110	ns
Turn–Off Delay Time	$t_{d(\text{off})}$		—	45	100	ns
Fall Time	$t_f$		—	30	70	ns
<b>Drain–Source Diode Characteristics and Maximum Ratings</b>						
Maximum Continuous Drain–Source Diode Forward Current	$I_S$		—	—	11.5	A
Maximum Pulsed Drain–Source Diode Forward Current	$I_{SM}$		—	—	46	A
Drain–Source Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0\text{V}, I_S = 11.5\text{A}$	—	—	1.4	V
Reverse Recovery Time	$t_{rr}$	$V_{GS} = 0\text{V}, I_{SD} = 11.5\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$	—	375	—	ns
Reverse Recovery Charge	$Q_{rr}$		—	3.5	—	$\mu\text{C}$

Note 4. Essentially independent of operating temperature typical characteristics.



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